

Hesse & Knipps Bondjet 820

Description:

- Year Manufactured: 2011

Configurations:

- Bond Head:
 - Bonding type: Fine-wire wedge type
 - Wire-feed angle: 90-degree (deep-access)
 - Transducer frequency: 98 kHz
 - Supported material: Both fine wire and ribbon
- Spool:
 - Applicable spool diameter: 2 × 1 inches
- Wire:
 - Supported wire diameter: 17.5–50 µm
- Work Stage:
 - Table specification: Vacuum chuck
 - Vacuum chuck mechanism: Yes
- Transfer Mechanism:
 - Removability: No transport locks are installed.
- Power Supply:
 - Equipment voltage: 230V 50/60Hz